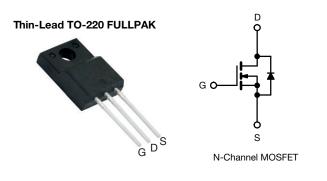
SiHA11N80E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.38				
Q _g max. (nC)	88				
Q _{gs} (nC)	9				
Q _{gd} (nC)	16				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA11N80E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	- 20 0, amo					
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	800	V	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current (T _J = 150 °C) ^a	V _{GS} at 10 V	T _C = 25 °C	1-	12	А	
		T _C = 100 °C	- I _D	8		
Pulsed drain current ^b			I _{DM}	32		
Linear derating factor				0.27	W/°C	
Single pulse avalanche energy ^c			E _{AS}	226	mJ	
Maximum power dissipation			PD	34	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		alı . / alt	70		
Reverse diode dv/dt d		dv/dt	4.3	V/ns		
Soldering recommendations (peak temperature) e	For	10 s		300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

a. Limited by maximum junction temperature

b. Repetitive rating; pulse width limited by maximum junction temperature

c. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,\,I_{AS}$ = 4.0 A

d. $I_{SD} \leq I_D, \, di/dt = 100 \; A/\mu s, \, starting \, T_J = 25 \; ^\circ C$

e. 1.6 mm from case

S17-1187-Rev. A, 31-Jul-17

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COMPLIANT HALOGEN



Vishay Siliconix

THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		65		°C ///		
Maximum junction-to-case (drain)	R _{thJC}	-	- 3.7			- °C/W		
		·						
SPECIFICATIONS (T _J = 25 °C, u	nless otherwis	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static					•	•	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C	, I _D = 1 mA	-	1.1	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2	-	4	V
			$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA
		V _{DS} = 800 V, V _{GS} = 0 V		-	-	1		
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V	V _{DS} = 640 V, V _{GS} = 0 V, T _J = 125 °C		-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	ار	₀ = 5.5 A	-	0.38	0.44	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D =	= 5.5 A	-	4.5	-	S
Dynamic		•				•	•	
Input capacitance	C _{iss}		$V_{GS} = 0 V,$		-	1670	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$		-	68	-	1	
Reverse transfer capacitance	C _{rss}		f = 1 MHz		-	9	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	43	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}			-	212	-		
Total gate charge	Qg				-	44	88	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 5.5 \text{ A}, V_{DS} = 480 \text{ V}$		-	9	-	nC	
Gate-drain charge	Q _{gd}				-	16	-	1
Turn-on delay time	t _{d(on)}				-	18	36	
Rise time	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 480 \; \text{V}, \; I_{\text{D}} = 5.5 \; \text{A}, \\ V_{\text{GS}} = 10 \; \text{V}, \; R_{\text{g}} = 9.1 \; \Omega \end{array}$		-	15	30	ns	
Turn-off delay time	t _{d(off)}			-	55	110		
Fall time	t _f			-	18	36		
Gate input resistance	R _g	f = 1 MHz, open drain		0.4	0.9	1.8	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous source-drain diode current	I _S	MOSFET symbol showing the		-	-	12	^	
Pulsed diode forward current	I _{SM}	integral revers p - n junction			-	-	32	A
		1				l		L

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

 V_{SD}

t_{rr}

Q_{rr}

I_{RRM}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS

Diode forward voltage

Reverse recovery time

Reverse recovery charge

Reverse recovery current

 T_J = 25 °C, I_S = 5.5 A, V_{GS} = 0 V

 T_J = 25 °C, I_F = I_S = 5.5 A, di/dt = 100 A/µs, V_R = 25 V

1.2

690

8.4

-

-

345

4.2

21

_

-

-

_

٧

ns

μC

А



SiHA11N80E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

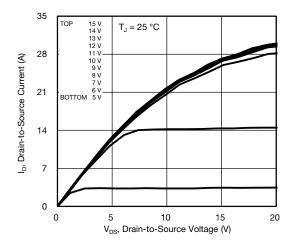
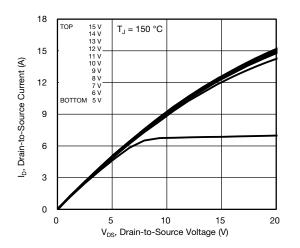
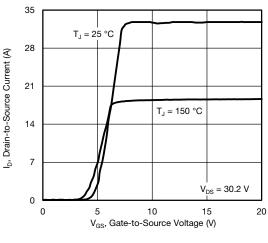


Fig. 1 - Typical Output Characteristics









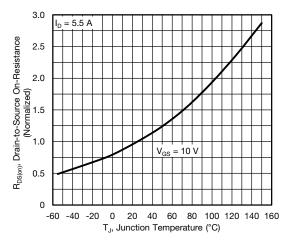


Fig. 4 - Normalized On-Resistance vs. Temperature

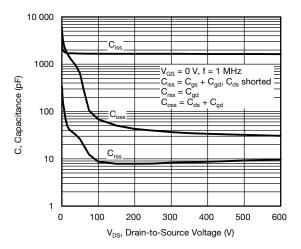


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

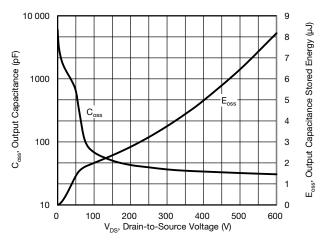


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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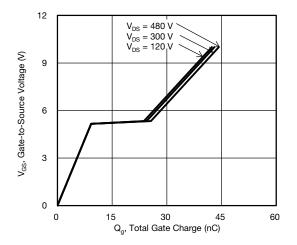


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

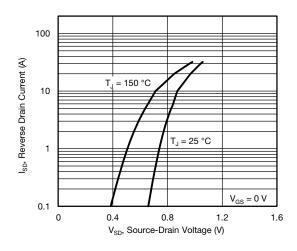


Fig. 8 - Typical Source-Drain Diode Forward Voltage

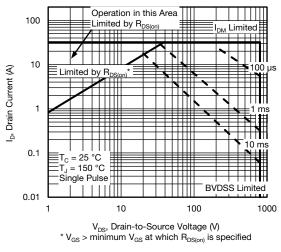


Fig. 9 - Maximum Safe Operating Area

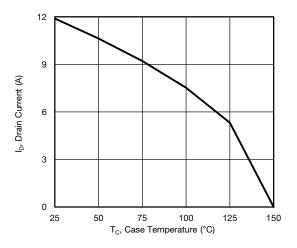


Fig. 10 - Maximum Drain Current vs. Case Temperature

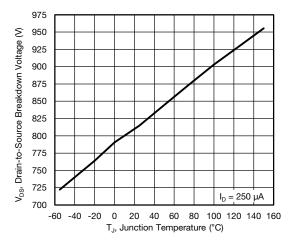
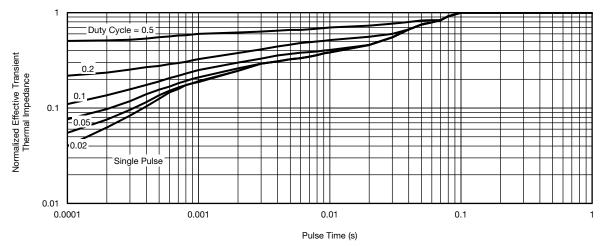


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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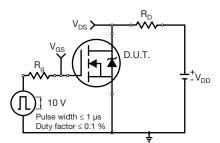


Fig. 13 - Switching Time Test Circuit

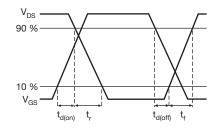


Fig. 14 - Switching Time Waveforms

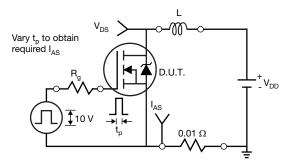


Fig. 15 - Unclamped Inductive Test Circuit

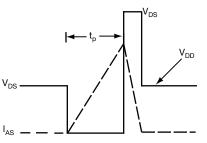


Fig. 16 - Unclamped Inductive Waveforms

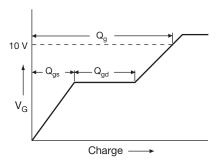


Fig. 17 - Basic Gate Charge Waveform

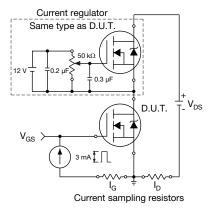


Fig. 18 - Gate Charge Test Circuit

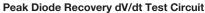
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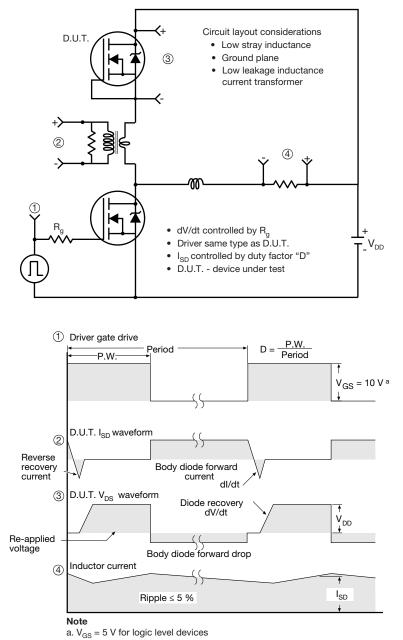


Fig. 19 - For N-Channel

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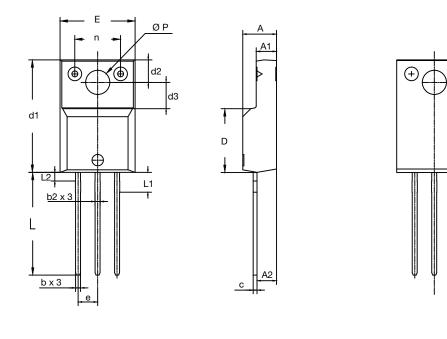
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TO-220 FULLPAK Thin Lead





	DIMENSIONS					
SYMBOL	MILLIN	IETERS	INC	ES		
	MIN.	MAX.	MIN.	MAX.		
А	4.30	4.70	0.169	0.185		
A1	2.50	2.90	0.098	0.114		
A2	2.50	2.70	0.098	0.106		
b	0.60	0.80	0.024	0.031		
b2	0.60	0.90	0.024	0.035		
С	-	0.60	-	0.024		
D	8.30	8.70	0.327	0.342		
d1	14.70	15.30	0.579	0.602		
d2	2.90	3.10	0.114	0.122		
d3	3.40	3.60	0.134	0.142		
E	9.70	10.30	0.382	0.406		
е	2.50	2.70	0.098	0.106		
L	13.40	13.80	0.528	0.543		
L1	2.50	2.80	0.098	0.110		
L2	-	1.20	-	0.047		
n	6.05	6.15	0.238	0.242		
ØP	3.00	3.40	0.118	0.134		

Revision: 12-Sep-16

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